PESDHC2FD5VBH
ESD PROTECTION DIODE

Discription

Low capacitance bidirectional ElectroStatic Discharge (ESD) protection diode in a DFN1006(SOD-882) leadless ultra small Surface-Mounted Device (SMD) plastic package designed to protect one signal line from the damage caused by ESD and other transients.



DFN1006-2L



Circuit Diagram

Features

★ Bidirectional ESD protection of one line
★ Femtofarad capacitance: Cj = 60pF (Typ)
★ Low clamping voltage VC = 9.0 V@30A(Typ)
★ Low leakage current: nA Level
★ ESD protection up to 30 kV
★ IEC 61000-4-2; level 4 (ESD)
★ IEC 61000-4-5 (surge); IPPM = 30A

Applications

★ Portable electronics
★ Computers and peripherals
★ Audio and video equipment
★ Cellular handsets and accessories
★ Communication systems
★ Power supplies

Ordering Information

Product ID	Pack	Qty(PCS)
PESDHC2FD5VBH	DFN1006-2L	10000

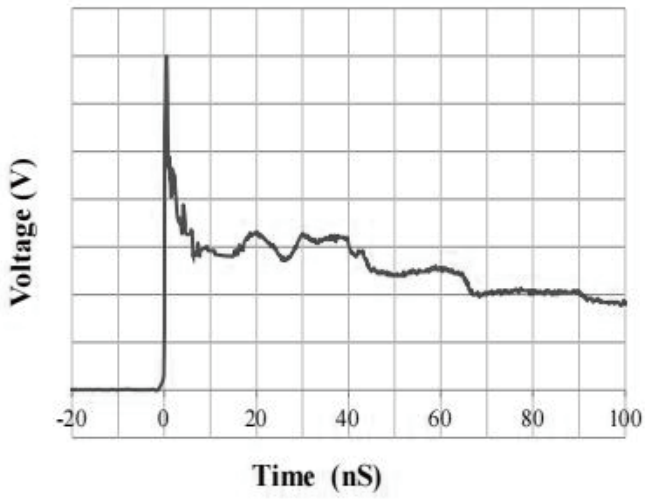
Absolute Ratings(Tamb = 25°C)

Symbol	Parameter	Value	Units
P_{PP}	Peak Pulse Power (t_p = 8/20 μ s)	300	W
T_L	Maximum lead temperature for soldering during 10s	260	°C
T_{stg}	Storage Temperature Range	-55 to +150	°C
T_{op}	Operating Temperature Range	-55 to +150	°C
T_j	Maximum junction temperature	150	°C
	IEC61000-4-2 (ESD) air discharge contact discharge	±30 ±30	KV
	IEC61000-4-4 (EFT)	40	A

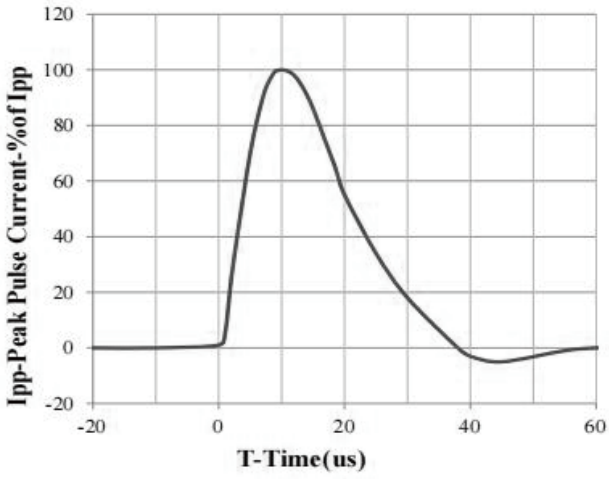
Electrical Characteristics

Symbol	Parameter	Test Condition	Min	Typ	Max	Units
V_{RWM}	Reverse Working Voltage				5.0	V
V_{BR}	Reverse Breakdown Voltage	I_T = 1mA	5.6		7.0	V
I_R	Reverse Leakage Current	V_{RWM} = 5.0V			100	nA
V_C	Clamping Voltage	I_{PP} =10A, t_p = 8/20μs		6.5	7.0	V
		I_{PP} =30A, t_p = 8/20μs		9.0	10.0	V
C_J	Junction Capacitance	V_R = 0V, f = 1MHz		60	80	pF

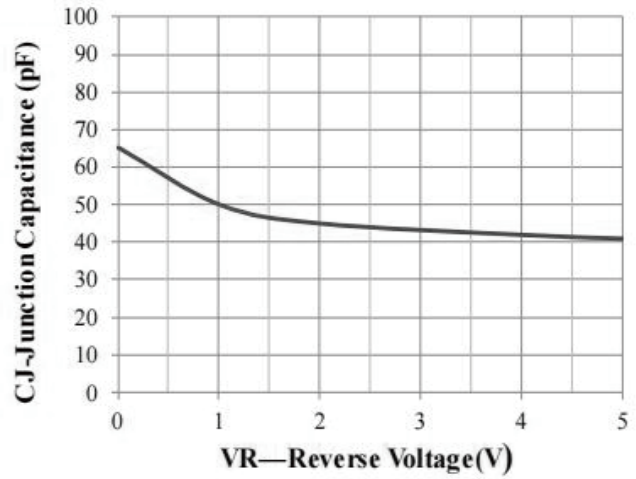
Typical Characteristics



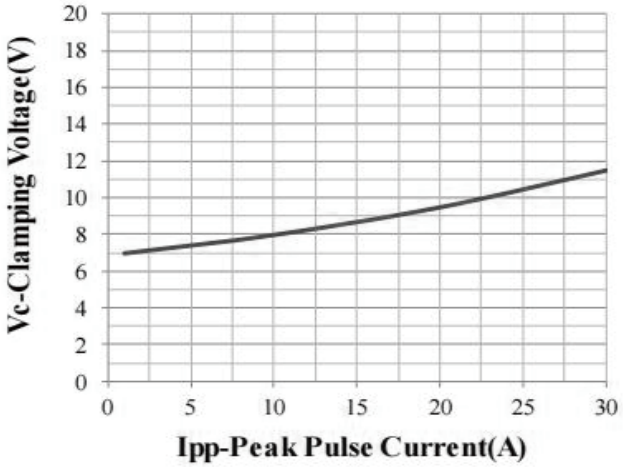
IEC61000−4−2 Pulse Waveform



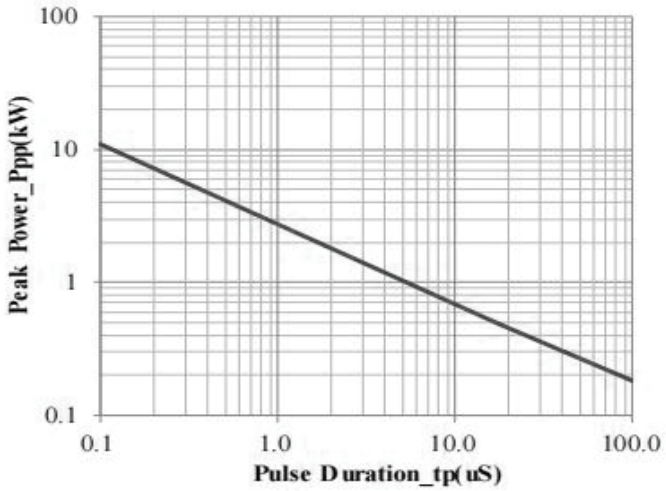
8 X 20us Pulse Waveform



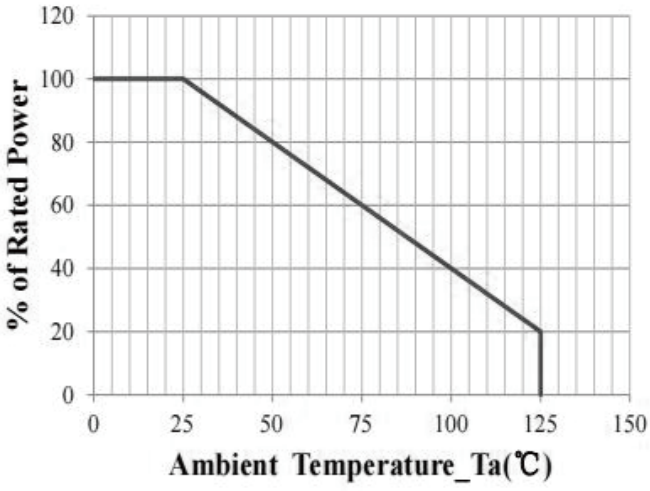
Junction Capacitance vs. Reverse Voltage



Clamping Voltage vs. Peak Pulse Current

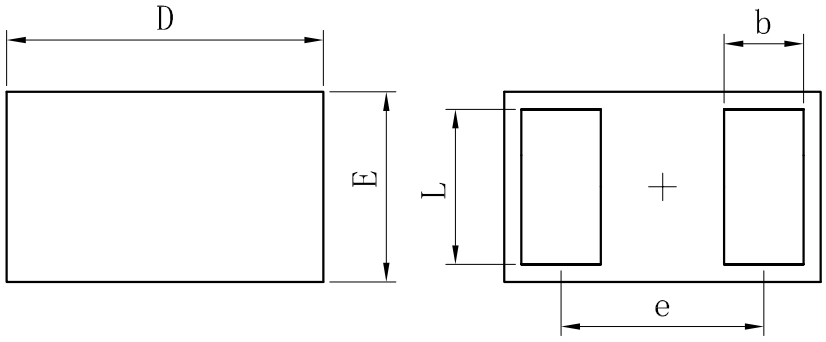


Peak Pulse Power vs. Pulse Time

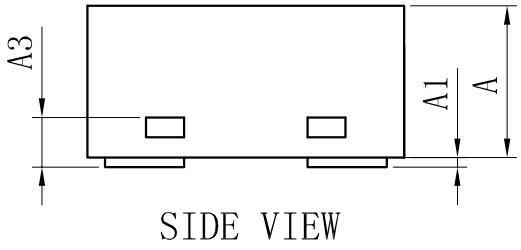


Power Derating Curve

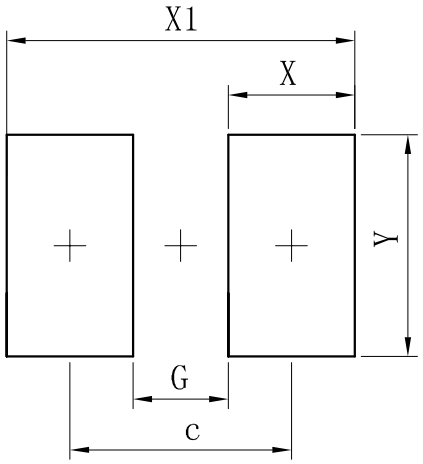
Outline And Dimensions



DFN1006-2L			
Dim	Min	Typ	Max
D	0.95	1.00	1.05
E	0.55	0.60	0.65
e	–	0.64	–
L	0.44	0.49	0.54
b	0.20	0.25	0.30
A	0.43	0.48	0.53
A1	0	–	0.05
A3	0.127REF.		
All Dimensions in mm			



Soldering Footprint



Dimensions	(mm)
c	0.70
G	0.30
X	0.40
X1	1.10
Y	0.70

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C3M0040120D ISL28133FHZ-T7 MUR1040FCT S4D15120H TPD1E0B04DPYR ISL28233FUZ-T7
S3D08065E TLV74318PDBVR-HXY 1SMB5934B 2N7002-HXY AOD403-HXY CH440G DMPH6250SQ-13
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